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APPLICATION NO.	F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/708,809	03/26/2004		Kazuhiro Umemoto	Љ920020021US1	2808
24241	7590	11/19/2004		EXAMINER	
IBM MICE			LUU, CH	LUU, CHUONG A	
INTELLECTUAL PROPERTY LAW 1000 RIVER STREET				ART UNIT	PAPER NUMBER
972 E			2825		
ESSEX JUN	ICTION,	VT 05452	DATE MAILED: 11/19/2004		

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
	10/708,809	UMEMOTO ET AL.					
Office Action Summary	Examiner	Art Unit					
	Chuong A Luu	2825					
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply							
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be time within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on							
2a) This action is <b>FINAL</b> . 2b) ☐ This	☐ This action is <b>FINAL</b> . 2b) ☑ This action is non-final.						
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Disposition of Claims	·						
4) ⊠ Claim(s) 1-7 is/are pending in the application. 4a) Of the above claim(s) is/are withdray 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) 1-7 is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and/or							
Application Papers							
9) The specification is objected to by the Examine	r.						
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.							
Applicant may not request that any objection to the	drawing(s) be held in abeyance. See	e 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the correcting 11) The oath or declaration is objected to by the Ex	• • • • • • • • • • • • • • • • • • • •	, ,					
Priority under 35 U.S.C. § 119							
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the prior application from the International Bureau * See the attached detailed Office action for a list of	s have been received. s have been received in Application ity documents have been receive I (PCT Rule 17.2(a)).	on No ed in this National Stage					
Attachment(s)							
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal Pa						

Application/Control Number: 10/708,809

Art Unit: 2825

#### **DETAILED ACTION**

## **PRIOR ART REJECTIONS**

## **Statutory Basis**

## Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

#### The Rejections

Claims 1-2 and 5 are rejected under 35 U.S.C. 102(e) as being anticipated by Masumoto et al. (U.S. 6,759,745 B2).

Masumoto discloses a semiconductor device with

(1) a substrate (102);

a first semiconductor chip (700) mounted on the substrate (102);

Application/Control Number: 10/708,809

Art Unit: 2825

a second semiconductor chip (100) mounted on the first semiconductor chip (700), and being smaller in size and thickness than the first semiconductor chip (700) (see Figure 7);

- (2) wherein an edge of a lower surface of the second semiconductor chip (100) confronting an upper surface of the first semiconductor chip (700) is chamfered (see Figure 7);
  - (5) a substrate (102);
  - a first semiconductor chip (700)mounted on the substrate (102);

a second semiconductor chip (100), mounted on the first semiconductor chip (700), being smaller in size than the first semiconductor chip (700), and having an edge of a lower surface of the second semiconductor chip (100) confronting an upper surface of the first semiconductor chip (700) that is chamfered (see Figure 7).

Claims 3-4 and 6-7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Masumoto et al. (U.S. 6,759,745 B2) in view of Pan (U.S. 6,501,663 B1).

Masumoto teaches the outlined features above except for wherein the second semiconductor chip is mounted on the first semiconductor chip other than in the center of the first semiconductor chip; wherein the size of the first semiconductor chip is at least twice the size of the second semiconductor chip. However, Pan discloses a three-dimensional interconnect system with (3); (6) wherein the second semiconductor chip (707) is mounted on the first semiconductor chip (701) other than in the center of the first semiconductor chip (701) (see column 14, lines 8-11. Figure 20); (4); (7) wherein

Art Unit: 2825

the size of the first semiconductor chip (701) is at least twice the size of the second semiconductor chip (707) (see Figure 20). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor device of Masumoto (accordance with the teaching of Pan) and also recognize the size of the devices. Doing so would facilitate the manufacture of the semiconductor device and obtain the optimized compact device structure.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Chuong A Luu whose telephone number is (571) 272-1902. The examiner can normally be reached on M-F (6:15-2:45).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew Smith can be reached on (571) 272-1907. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Chuong Anh Luu

Chung while

Examiner